

PRODUCT DATA SHEET

Sikafloor®-221 W Conductive

Epoxy water-based electrostatic conductive flooring primer

PRODUCT DESCRIPTION

Sikafloor®-221 W Conductive is a 2-part, epoxy, water-based, electrostatic conductive flooring primer with increased electrical resistance. It is part of the selected Sikafloor® ECF and ECD flooring systems.

USES

Sikafloor®-221 W Conductive installation works to be carried out only by Sika Approved Contractors. Please observe information given by Product Data Sheets.

- As a conductive primer below Sikafloor® electrostatic conductive floor coatings
- Flooring that needs to comply with the requirements of the standard VDE 100-600
- As conductive primer underneath selected Sikafloor® conductive wearing layers, such as Sikafloor®-262 AS N, -262 AS N Thixo, -235 ESD, -381 ECF, and -390 ECF.

CHARACTERISTICS / ADVANTAGES

- Water-based
- Easy to apply
- High electrostatic conductivity
- Applied by roller

ENVIRONMENTAL INFORMATION

Conformity with LEED v4 MR credit 4 option 2: Building product disclosure and optimization - Material ingredients

APPROVALS / STANDARDS

- CE Marking and Declaration of Performance to EN 1504-2 - Surface protection product for concrete - Coating
- CE Marking and Declaration of Performance to EN 13813 - Resin screed material for internal use in buildings
- Insulation Resistance DIN VDE 0100-600, Sikafloor® MultiDur ES-47 ECF, kiwa, Test report No. P 12174-4-E
- Insulation Resistance DIN VDE 0100-600, Sikafloor® MultiDur ES-47 ESD, kiwa, Test report No. P 12174-2-E
- Insulation Resistance DIN VDE 0100-600, Sikafloor® MultiDur ES-48 ECF, kiwa, Test report No. P 12174-3-E
- Insulation Resistance DIN VDE 0100-600, Sikafloor® MultiDur ES-49 ECF, kiwa, Test report No. P 12174-5-E
- Insulation Resistance DIN VDE 0100-600, Sikafloor® MultiDur ES-52 ESD, kiwa, Test report No. P 12174-1-E
- Test of floor IEC 61340-4-1, Sikafloor® MultiDur ES-52 ESD, RISE, Test report No. 9P07719 C
- IEC 61340-5-1, Sikafloor® MultiDur ES-52 ESD, RISE, Approval DNo. 230-19-0040

PRODUCT INFORMATION

Chemical Base	Water-based epoxy	
Packaging	Part A	4,98 kg container
	Part B	1,02 kg container
	Part A + B	6 kg unipacks
	Refer to current price list for packaging variations	
Appearance / Colour	Part A - resin	black, liquid
	Part B - hardener	white, liquid
	Final colour: black	
Shelf Life	12 months from date of production.	
Storage Conditions	The product must be stored in original, unopened and undamaged packaging in dry conditions at temperatures between +5 °C and +30 °C. Always refer to packaging.	
Density	Part A	1,15 kg/l (DIN EN ISO 2811-1)
	Part B	1,09 kg/l
	Mixed Resin	1,14 kg/l
	Values at +23 °C.	
Solid content by mass	~40 %	
Solid content by volume	~32 %	

TECHNICAL INFORMATION

Electrostatic Behaviour	Typical average resistance to ground:	$R_g \leq 10^4 \Omega^*$	(DIN EN 1081)
	In combination with a Sika® electrostatic conductive floor covering:	$R_g \geq 10^7 \Omega \leq 10^9 \Omega^*$	
	* Readings may vary, depending on ambient conditions (i.e. temperature, humidity) and measurement equipment.		

SYSTEM INFORMATION

Systems	Reference must be made to the following System Data Sheets: <ul style="list-style-type: none">▪ Sikafloor® Multidur ES-47 ECF▪ Sikafloor® Multidur ES-47 ESD▪ Sikafloor® Multidur ES-48 ECF▪ Sikafloor® Multidur ES-49 ECF▪ Sikafloor® Multidur ES-52 ESD
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APPLICATION INFORMATION

Mixing Ratio	Part A : Part B = 83 : 17 (by weight)
Consumption	~0,08–0,10 kg/m ² This figure is theoretical and does not allow for any additional material due to surface porosity, surface profile, variations in level or wastage etc. For detailed information, refer to the System Data Sheets.
Ambient Air Temperature	+10 °C min. / +30 °C max.
Relative Air Humidity	75 % max.
Dew Point	Beware of condensation. The substrate and uncured applied floor material must be at least +3 °C above dew point to reduce the risk of condensation or blooming on the

floor finish.

Substrate Temperature	+10 °C min. / +30 °C max.	
Substrate Moisture Content	≤ 4 % parts by weight The following test methods can be used: Sika®-Tramex meter, CM-measurement or Oven-dry-method. No rising moisture according to ASTM (Polyethylene-sheet).	
Pot Life	Temperatures	Time
	+10 °C	~120 minutes
	+20 °C	~90 minutes
	+30 °C	~30 minutes
Curing Time	Before overcoating Sikafloor®-221 W Conductive allow:	
	Substrate temperature	Minimum Maximum
	+10 °C	26 hours 7 days
	+20 °C	17 hours 5 days
+30 °C	12 hours 4 days	
Times are approximate and will be affected by changing ambient conditions particularly temperature and relative humidity.		
Applied Product Ready for Use	Temperature	Foot traffic
	+10 °C	~26 hours
	+20 °C	~13 hours
	+30 °C	~8 hours
Times are approximate and will be affected by changing ambient conditions particularly temperature and relative humidity.		

VALUE BASE

All technical data stated in this Data Sheet are based on laboratory tests. Actual measured data may vary due to circumstances beyond our control.

FURTHER DOCUMENTS

- Sika Method Statement: Evaluation and Preparation of Surfaces for Flooring Systems
- Sika Method Statement: Mixing & Application of Flooring Systems

LIMITATIONS

- Do not apply Sikafloor®-221 W Conductive on substrates with rising moisture.
- The incorrect assessment and treatment of cracks may lead to a reduced service life, reflective cracking and reducing or breaking the conductivity.
- Apply only on primed or levelled concrete and screed surfaces.
- Do not blind the primer.
- After application, all the products must be protected from damp, condensation and water for at least 24 hours.
- Only start application of the Sikafloor® conductive primer after all the primer has dried tack-free. This prevents the risk of 'wrinkling' affecting the conductive properties.
- After curing of the Sikafloor® conductive primer and before application of the subsequent conductive wearing layers. Conductivity testing of the conductive primer must be carried out. All readings must be

below 10⁴ Ohm. Resistance to ground: Insulation Tester Metriso 2000 from Warmbier or comparable. Surface resistance probe: Carbon Rubber electrode. Weight: 2,50 kg (+/- 0,25 kg); Diameter: 65 mm (+/- 5 mm); Rubber pad hardness: Shore A 60 (+/- 10).

- Only grounding points from the Sikafloor® Earthing Kit may be used to ground the floor.
- Do not use self-adhesive copper tape as this can lead to low conductivity of the floor and would no longer comply with the requirements of the standard: VDE100-610.
- The protective effect is not given at the earthing point or ~10 cm around the earthing point. These areas must be marked accordingly and covered by a rubber mat with a resistance of > 1 M Ohm.
- Sikafloor®-221 W Conductive must only be used as conductive primer in conjunction with Sikafloor®-262 AS N/thixo, Sikafloor®-381 ECF, Sikafloor®-390 ECF and Sikafloor®-235 ESD. Do not use in conjunction with other conductive flooring resins.
- If temporary heating is required do not use gas, oil, paraffin or other fossil fuel heaters, these produce large quantities of both CO₂ and H₂O water vapour, which may adversely affect the finish. For heating use only electric powered warm air blower systems.

ECOLOGY, HEALTH AND SAFETY

Local safety regulations must be observed and it advisable to wear PPI when working with this product with particular attention paid to cutting and handling. Transportation Class: The product is not classified as hazardous good for transport. Disposal: The material is recyclable. Disposal must be according to local regula-

tions. Please contact your local Sika sales organisation for more information.

APPLICATION INSTRUCTIONS

SUBSTRATE QUALITY / PRE-TREATMENT

Cementitious substrates (concrete / screed) must be structurally sound and of sufficient compressive strength (minimum 25 N/mm²) with a minimum tensile strength of 1,5 N/mm².

Substrates must be clean, dry and free of all contaminants such as dirt, oil, grease, coatings, laitance, surface treatments and loose friable material.

Cementitious substrates must be prepared mechanically using suitable abrasive blast cleaning or planing / scarifying equipment to remove cement laitance and achieve an open textured gripping surface profile suitable for the product thickness.

High spots can be removed by grinding.

Weak cementitious substrates must be removed and surface defects such as blow holes and voids must be fully exposed.

Repairs to the substrate, filling of cracks, blowholes/voids and surface levelling must be carried out using products from the Sikafloor®, Sikadur® and Sikagard® range of materials. Products must be cured before applying Sikafloor®-221 W Conductive.

All dust, loose and friable material must be completely removed from all surfaces before application of the product and associated system products, preferably by vacuum extraction equipment.

MIXING

Prior to mixing all parts, mix separately Part A (resin) using an electric single paddle mixer (300–400 rpm) or other similar equipment. Mix liquid and all the coloured pigment until a uniform colour / mix has been achieved. Add Part B (hardener) to Part A and mix Part A + B continuously for 2,0 minutes until a uniformly coloured mix has been achieved. To ensure thorough mixing pour materials into a clean container and mix again for at least 1,0 minute to achieve a smooth consistent mix. Excessive mixing must be avoided to minimise air entrainment. During the final mixing stage, scrape down the sides and bottom of the mixing container with a straight edge trowel or spatula at least once to ensure complete mixing. Mix full units only. Mixing time for A+B = ~3,0 minutes.

APPLICATION

Apply Sikafloor®-221 W Conductive onto the prepared, primed substrate and apply by short pile nylon roller (12 mm) then back roller in two directions at right angles to each other. Ensure a continuous, pore free coat covers the substrate.

Confirm waiting /overcoating time has been achieved before applying subsequent products.

CLEANING OF TOOLS

Clean all tools and application equipment with water immediately after use. Hardened material can only be removed mechanically.

LOCAL RESTRICTIONS

Note that as a result of specific local regulations the declared data and recommended uses for this product may vary from country to country. Consult the local Product Data Sheet for the exact product data and uses.

LEGAL NOTES

The information, and, in particular, the recommendations relating to the application and end-use of Sika products, are given in good faith based on Sika's current knowledge and experience of the products when properly stored, handled and applied under normal conditions in accordance with Sika's recommendations. In practice, the differences in materials, substrates and actual site conditions are such that no warranty in respect of merchantability or of fitness for a particular purpose, nor any liability arising out of any legal relationship whatsoever, can be inferred either from this information, or from any written recommendations, or from any other advice offered. The user of the product must test the product's suitability for the intended application and purpose. Sika reserves the right to change the properties of its products. The proprietary rights of third parties must be observed. All orders are accepted subject to our current terms of sale and delivery. Users must always refer to the most recent issue of the local Product Data Sheet for the product concerned, copies of which will be supplied on request.

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